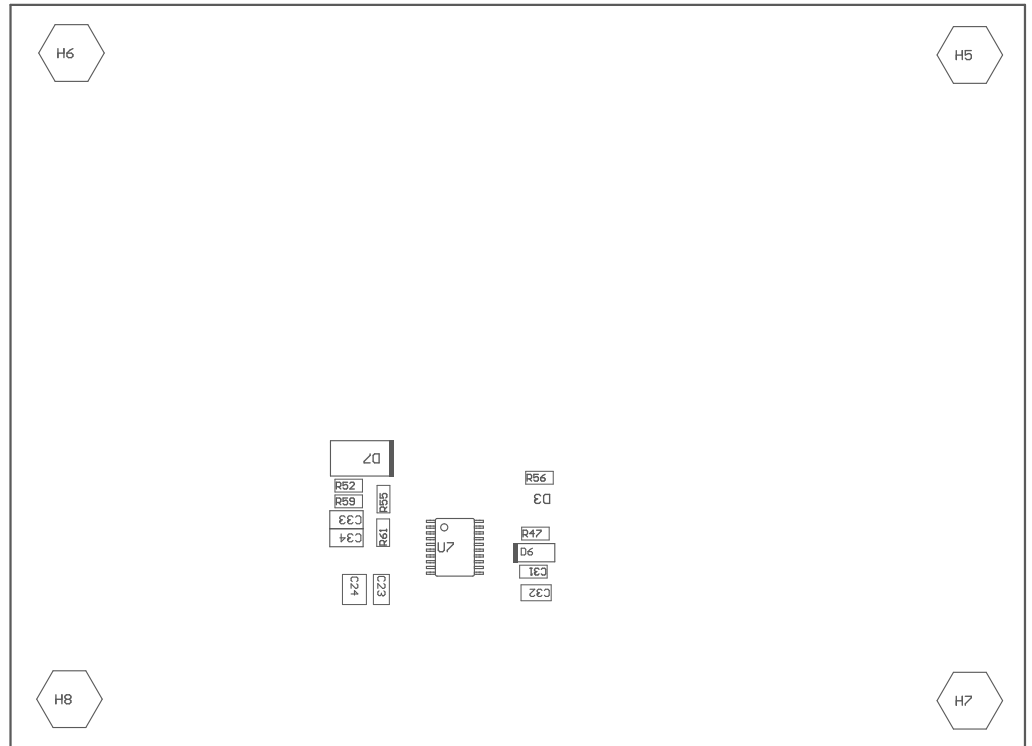


PCB VIEWED FROM TOP SIDE	BOARD #:	REV: E1	SUN REV: Not In VersionControl
	TID #:		
PLOT NAME = Top Assembly Drawing	GENERATED : 5/31/2017 9:34:13 AM	TEXAS INSTRUMENTS	




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